



MULTI GPU SERVER
WITH 2 X NVIDIA P5000
XEON® E-2276ML



MULTI GPU SERVER

- SFF Rugged PCIe/104 computer with Intel®9th Gen Xeon® E-2276ML CPU (6 cores, 4.2GHz)
- 2 x NVIDIA® Quadro Embedded P5000 MXM GPU (2048 CUDA, 16GB GDDR5)
- DDR4-2666 Up to 128GB
- DC-DC 18V~36V, MIL-STD 461/1275
- MIL-STD 810 Shock up to 75Grms
- Operating Temp. -40°C~+55°C

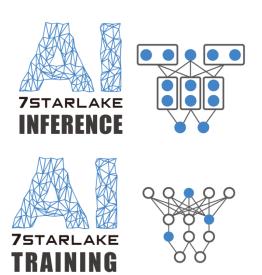
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1. Features

1-1 CPU GPU Platform – Al Training / Inference



Artificial Intelligence (AI) is accelerating the tactical capability of the military more than ever before. Many new combat and weapons systems utilize embedded AI, making them more efficient and less dependent on human operation.

Furthermore, SWaP (Reduced Size, Weight, and Power) requirements are also impacting artificial intelligence design. Now and in the future, many military systems will be susceptible to SWaP-constraints, which challenge the assumptions of today's Al solutions.

7Starlake excels in designing unparalleled military computers for harsh environments. From polar regions to

the desert, from jungle environments to high altitude, 7Starlake's rugged computers have the capability to withstand the operational environment. Tested to MIL-STD standards exacting levels of conformity, 7Starlake products can operate at full capacity in extreme conditions. 7Starlake believes in meeting 100% of our customers' expectations for the design, quality of build, and customer service levels in the supply of rugged and custom-built computer systems.

1-2 MIL-STD 810G & Full IP65 protection

AV701-X2 is designed to meet strict SWaP requirements and to withstand harsh environments, including extreme temperature, shock/vibration, sand/dust, and salt/fog. With ruggedized design and high functionality, the IP65 and MIL-STD resistance AV701-X2 is the ideal tactical vehicle on the battlefield.



1-3 Why does MIL-STD 461 matter

On the battlefield, where every second counts, a rugged HPEC connected to multiple sensors should be capable of tackling all affairs simultaneously in regard to processing a great amount of data identity, sorting data, and passing along the correct path. In this frame, EMC ability is undoubtedly indispensable. MIL-STD-461 testing offers an added layer of EMI protection for military systems and reassurance to military personnel that their systems won't be disrupted by EMI.

No matter what kind of robust CPU/GPU configuration a client requests, such as Intel XEON plus NVIDIA Quadro, or Intel Xeon Scalable paired with NVIDIA Tesla T4, TDW might become 500W even up to 1000W. That may present a big challenge for both power and thermal system design.

Despite such challenges, the 7Starlake team continues to produce high-spec and unrivalled MIL-STD-461 computing systems by using the full range of EMI filter power modules. These include both the SK710 (10V-40V 150W) and SK711 (18V-36V 300W) which succumb to and pass the strictest and most rigorous EMI/EMS tests.



1-4 System main board: EBX SBC-OXY5741A



The 3.5 EBX SBC OXY5741A provides extraordinary computing performance under extreme environment. It is powered by 9th / 8th Gen Intel® Xeon® / Core ™. Featuring Intel's Xeon E-2276ML and ruggedized open-standard EBX architecture, 7Starlake EBX series is built tentatively and triumphs on environmental testing. It still operates effectively under harsh environments ranging from -40 to 85°C so that it is a perfect solution for defense, transportation, and automation applications. More key functions such as stackable PCle/104

expansion ability, flexible I/O, and NVMe Gen 3.0 PClex4 for fast and large capacity storage, all contribute to this versatile architecture that can meet clients' needs.

Choosing an embedded architecture for computer systems can be a formidable task. This kind of stackable and mezzanine architecture often results in tradeoffs that include off-the-shelf or custom design requirements. PCle/104 compact, ruggedised, easily expandable traits support a lot of expansion flexibility in systems. This architecture evolved to address these resulting issues by keeping the common background while eliminating limitations. OXY5741 employs PCle/104

technology to reduce constraints and create flexibility of expansion. Its M.2 extension offers M-key (M-Key 2280 optional), and PCle 3.0 x 4 NVMe. Additionally, OXY5741 provides 3.0 ports for data redundancy by supporting RAID 0/1.



1-5 Intel® Xeon® E-2200 Processor

Featuring improvements in processor speeds, higher core count options, expanded enclave capacities, and more, Intel® Xeon® E-2200 processors deliver a significant impact, especially compared with hardware that is just a few years old. With up to a 2X overall performance increase,1 compared to 2015 Intel® Xeon® E3-1200v5 processors, Intel® Xeon® E-2200 processors

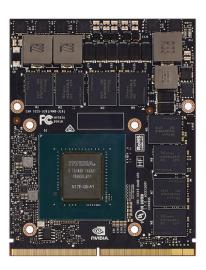


deliver performance to manage today's most demanding entry server workloads and offer significant advantages over much of the existing installed base. Even compared to the prior generation of Intel® Xeon® E-2100 processors, Intel® Xeon® E-2200 processors deliver up to a 1.2X increase in performance.2 And both of these latest generations are pin compatible, and use the same Intel® 240 series chipsets.

1-6 NVIDIA QUADRO P5000

The Quadro P5000 workstation graphics card, powered by NVIDIA Pascal™ GPU technology, features 16 GB memory capacity and enables an expansive visual workspace with quad display outputs. Work with larger models, complex visual effects and simulations, larger rendering tasks, and more life-like VR experiences in your workflow today and be well prepared for the challenges of tomorrow.

SPECIFICATION	
GPU Architecture	NVIDA Pascal
Graphics Processing Unit	NVIDA Quadro Embedded P5000m
NVIDA CUDA Core	2048SP
Memory Size	16G 256 bit GDDR5
Graphics Clock	1278MHz/1582MHz(Boost)
Memory Clock	1502MHz(6.0 Gbps)
Single Precision FLOPS	6494 GFLOPS
Double Precision FLOPS	209.1 GFLOPS
Board Dimensions	MXM Graphics Module Version 3.1 Type B (105 X 82 mm)
Display Features	DP A: Display Port 1.3 DP B: Display Port 1.3 DP C: Display Port 1.3 DP D: Display Port 1.3
Board Power	112W
Operation System	Windows 10 64 bit ` Linux 64bit
Operation Temperature	0° to 55° C



2. Specification

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CPU	INTEL 9th Gen. XEON 2276ML (6 cores, 4.2GHz)		
Memory type	4 x SO-DIMM DDR4 2666 MHz up to 128GB		
GPU	2 x NVIDIA Quadro P5000 GPU (2048 CUDA, 16GB GDDR5)		
STORAGE			
Storage 1	1 x NVMe (M.2), up to 2TB		
Storage 2	1 x mSATA, up to 1TB		
ETHERNET			
LAN	Intel® I210iT & I219LM GbE LAN (10/100/1000 Mbps supported)		
FRONT I/O			
USB	2 x USB, Rugged M12 connector		
Ethernet	2 x LAN, Rugged M12 connectors		
Series port	2 x COM, Rugged M12 connector		
DVI	3 x DVI, Rugged M12 connector		
DC-IN	1 x DC-IN 18V~36V, Rugged M12 connector		
Power Requirem	IENT		
Power Input	18V~36V DC-DC 300W		
APPLICATIONS &	DPERATING SYSTEM		
OS	WIN10 ,WINDOWS SERVER2016, UBUNTU 18.04,UBUNTU20.04		

3. Dimension

